DISCRETE SEMICONDUCTORS

DATA SHEET

BFT93PNP 5 GHz wideband transistor

Product specification

November 1992



PNP 5 GHz wideband transistor

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DESCRIPTION

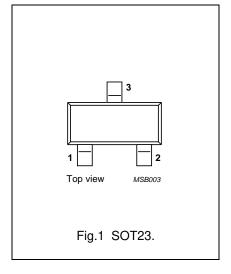
PNP transistor in a plastic SOT23 envelope.

It is primarily intended for use in RF wideband amplifiers, such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analyzers, etc. The transistor features low intermodulation distortion and high power gain; due to its very high transition frequency, it also has excellent wideband properties and low noise up to high frequencies.

NPN complements are BFR93 and BFR93A.

PINNING

PIN	DESCRIPTION		
Code: X1p			
1	base		
2	emitter		
3	collector		



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-15	V
V _{CEO}	collector-emitter voltage	open base	-	-12	V
I _c	DC collector current		-	-35	mA
P _{tot}	total power dissipation	up to T _s = 95 °C; note 1	-	300	mW
f _T	transition frequency	$I_{C} = -30 \text{ mA}; V_{CE} = -5 \text{ V}; f = 500 \text{ MHz};$ $T_{j} = 25 ^{\circ}\text{C}$	5	_	GHz
C _{re}	feedback capacitance	$I_C = -2 \text{ mA}; V_{CE} = -5 \text{ V}; f = 1 \text{ MHz}$	1	_	pF
G _{UM}	maximum unilateral power gain	$I_{C} = -30 \text{ mA}; V_{CE} = -5 \text{ V}; f = 500 \text{ MHz};$ $T_{amb} = 25 ^{\circ}\text{C}$	16.5	_	dB
F	noise figure	$I_{C} = -10 \text{ mA}; V_{CE} = -5 \text{ V}; f = 500 \text{ MHz}; $ $T_{amb} = 25 ^{\circ}\text{C}$	2.4	_	dB
Vo	output voltage	$\begin{aligned} & d_{im} = -60 \text{ dB; } I_C = -30 \text{ mA;} \\ & V_{CE} = -5 \text{ V; } R_L = 75 \Omega; \\ & f_{(p+q-r)} = 493.25 \text{ MHz} \end{aligned}$	300	_	mV

Note

1. T_s is the temperature at the soldering point of the collector tab.

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LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-15	٧
V _{CEO}	collector-emitter voltage	open base	-	-12	٧
V _{EBO}	emitter-base voltage	open collector	_	-2	٧
Ic	DC collector current		_	-35	mA
I _{CM}	peak collector current	f > 1 MHz	-	-50	mA
P _{tot}	total power dissipation	up to T _s = 95 °C; note 1	_	300	mW
T _{stg}	storage temperature		-65	150	°C
T _j	junction temperature		_	175	°C

THERMAL RESISTANCE

SYMBOL	PARAMETER	CONDITIONS	THERMAL RESISTANCE	
R _{th j-s}	thermal resistance from junction to soldering point	up to $T_s = 70 ^{\circ}C$; (note 1)	260 K/W	

Note

1. $T_{\mbox{\scriptsize S}}$ is the temperature at the soldering point of the collector tab.

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CHARACTERISTICS

 $T_i = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector cut-off current	$I_E = 0; V_{CB} = -5 \text{ V}$	_	_	-50	nA
h _{FE}	DC current gain	$I_C = -30 \text{ mA}; V_{CE} = -5 \text{ V}$	20	50	_	
f⊤	transition frequency	$I_C = -30 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 500 MHz	_	5	_	GHz
C _c	collector capacitance	$I_E = i_e = 0$; $V_{CB} = -10 \text{ V}$; $f = 1 \text{ MHz}$	_	0.95	_	рF
C _e	emitter capacitance	$I_c = I_c = 0$; $V_{EB} = -0.5 \text{ V}$; $f = 1 \text{ MHz}$	_	1.8	_	pF
C _{re}	feedback capacitance	$I_C = -2 \text{ mA}; V_{CE} = -5 \text{ V}; f = 1 \text{ MHz}$	_	1	_	pF
G _{UM}	maximum unilateral power gain (note 1)	$I_C = -30 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 500 MHz; $T_{amb} = 25 \text{ °C}$	_	16.5	_	dB
F	noise figure	$I_C = -10 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 500 MHz; $T_{amb} = 25 \text{ °C}$	_	2.4	_	dB
Vo	output voltage	see Fig.2 and note 2	_	300	_	mV

Notes

1. G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and

$$G_{UM} = 10 \log \frac{|S_{21}|^2}{(1 - |S_{11}|^2)(1 - |S_{22}|^2)} dB.$$

2. d_{im} = -60 dB (DIN 45004B); I_C = -30 mA; V_{CE} = -5 V; R_L = 75 Ω ;

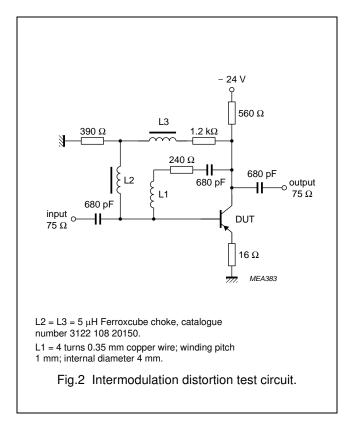
 $V_p = V_o$ at $d_{im} = -60$ dB; $f_p = 495.25$ MHz; $V_q = V_o - 6$ dB; $f_q = 503.25$ MHz;

 $V_r = V_o -6 \text{ dB}; f_r = 505.25 \text{ MHz};$

measured at $f_{(p+q-r)} = 493.25$ MHz.

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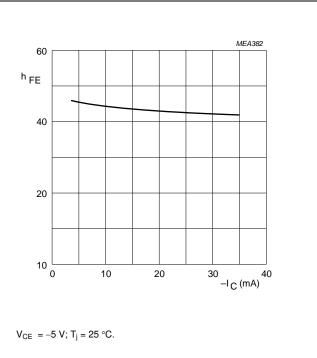


Fig.3 DC current gain as a function of collector current.

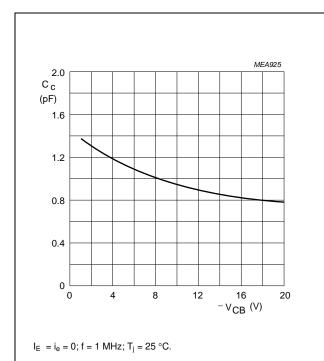
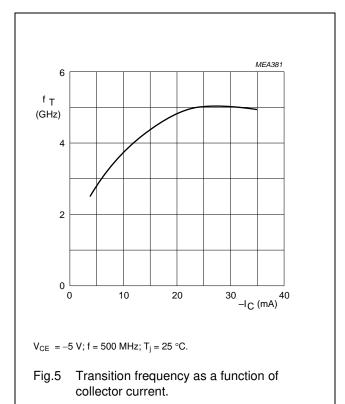


Fig.4 Collector capacitance as a function of collector-base voltage.



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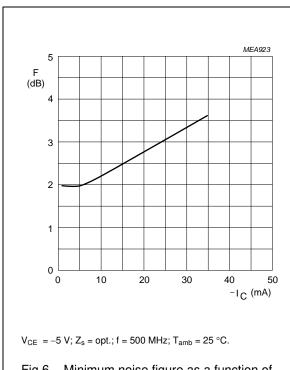


Fig.6 Minimum noise figure as a function of collector current.

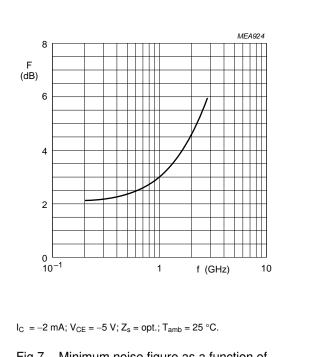


Fig.7 Minimum noise figure as a function of frequency.

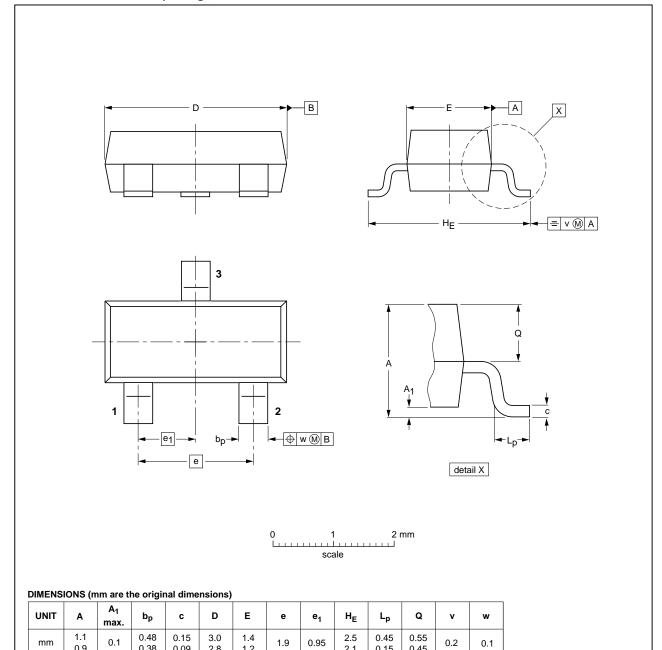
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PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT23



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT23		TO-236AB				-04-11-04- 06-03-16

0.9

0.38

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DATA SHEET STATUS

DOCUMENT STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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